

REMARKS

Claims 1 through 12 and 15 through 25 are in the application, with Claims 1 through 9 and 15 through 19 having been withdrawn. Claims 13 and 14 have been cancelled, Claims 10 and 20 have been amended, and Claim 26 has been added. Claims 10 and 26 are independent. No new matter has been added. Reconsideration and further examination are respectfully requested.

Claim 10

Applicants gratefully acknowledge the indication of allowable subject matter with respect to Claims 14 and 20 through 25. Claim 10 has been rewritten to recite the features of dependent Claim 14 and intervening dependent Claim 13. Accordingly, independent Claim 10 is believed to be allowable and withdrawal of the rejection thereof is respectfully requested.

Claim 26

Newly-added independent Claim 26 relates to a system including a first set of conductors, a second set of conductors, and a housing to physically couple the first set of conductors to the second set of conductors. The first set of conductors is electrically couplable to respective ones of first conductive elements of an upper surface of an integrated circuit package, and is to receive first input/output signals from the first conductive elements. The first conductive elements are to receive the first input/output signals from first conductive elements of an integrated circuit die.

The second set of conductors is electrically couplable to respective ones of second conductive elements of a lower surface of the integrated circuit package, and is to receive second input/output signals from the second conductive elements. Moreover, the second conductive elements are to receive the second input/output signals from second conductive elements of the integrated circuit die.

The cited art is not seen to disclose or to suggest the foregoing features of independent Claim 26. In particular, the cited art is not seen to disclose or to suggest a first set of conductors that is electrically couplable to respective ones of first conductive elements of an upper surface

of an integrated circuit package, and is to receive first input/output signals from the first conductive elements, and a second set of conductors that is electrically couplable to respective ones of second conductive elements of a lower surface of the integrated circuit package, and is to receive second input/output signals from the second conductive elements.

FIG. 10 of cited U.S. Patent No. 3,757,029 to Marshall illustrates cable 64 including layers 66, 69 and 70 of conductors. U.S. Patent 6,776,658 to Tang describes electrical cable 3, which is coupled to two electrical connectors 2 enclosed in cover 5. Neither cited patent discloses or suggests conductors that are couplable to conductive elements of an integrated circuit package. Consequently, the cited patents cannot be seen to disclose or to suggest a first set of conductors that is electrically couplable to respective ones of first conductive elements of an upper surface of an integrated circuit package, and a second set of conductors that is electrically couplable to respective ones of second conductive elements of a lower surface of the integrated circuit package.

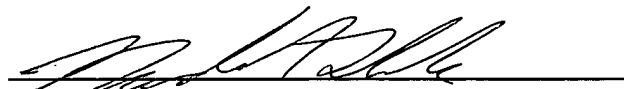
None of the other art of record is sent to remedy the foregoing deficiencies of Marshall and Tang. Accordingly, Claim 26 and its dependent Claims 20 through 25 are believed to be allowable.

CONCLUSION

In view of the above, Applicants respectfully request withdrawal of the outstanding rejections and allowance of the present application. Applicants' silence with respect to statements made in the Office Action but not addressed herein does not imply agreement with those statements. If the Examiner has any suggestions for expediting allowance of the present application, the Examiner is kindly invited to contact the undersigned.

Respectfully submitted,

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